

Sodium Penetration Through Solid-State NaSICON Electrolytes Under High Current

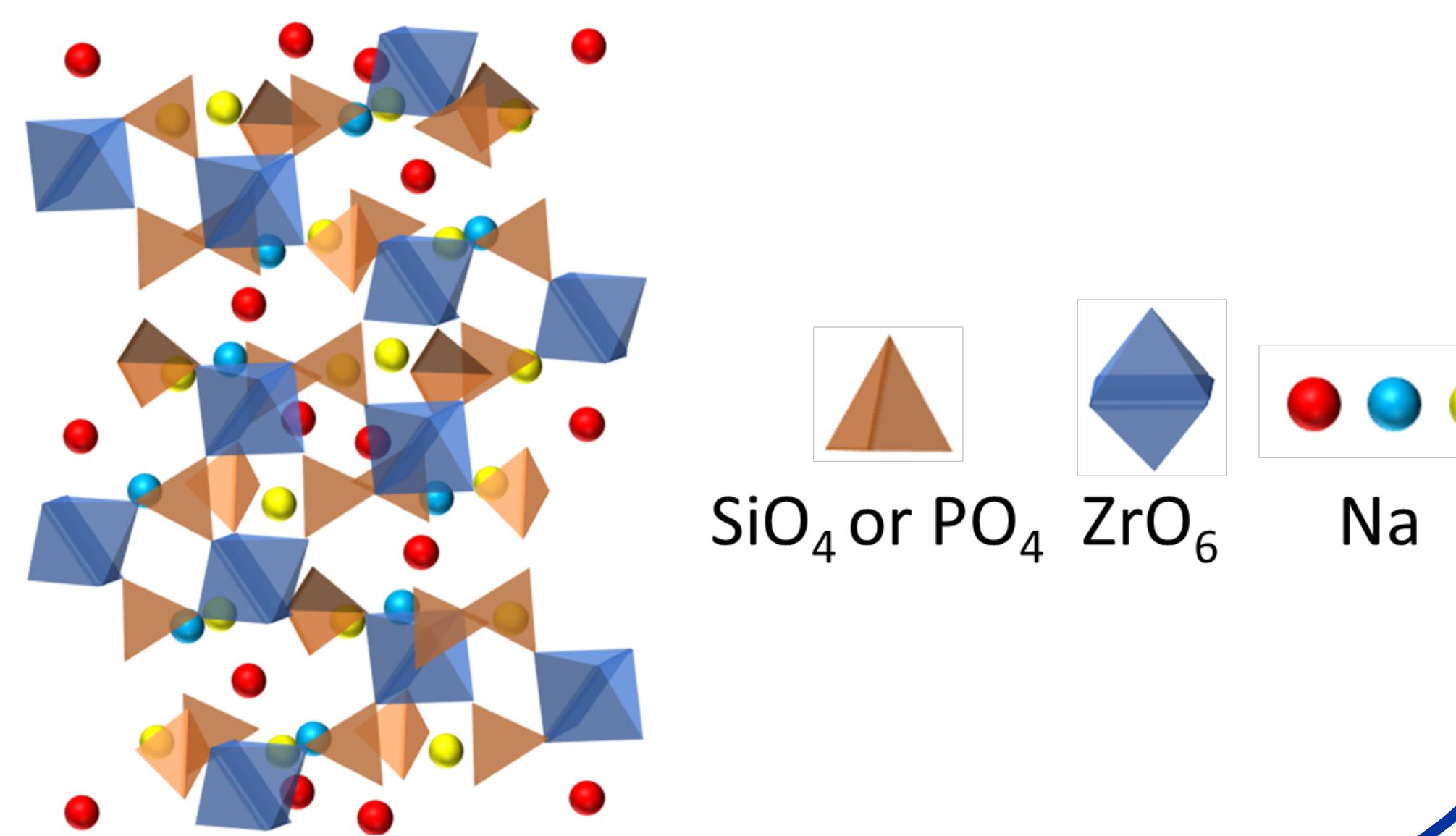
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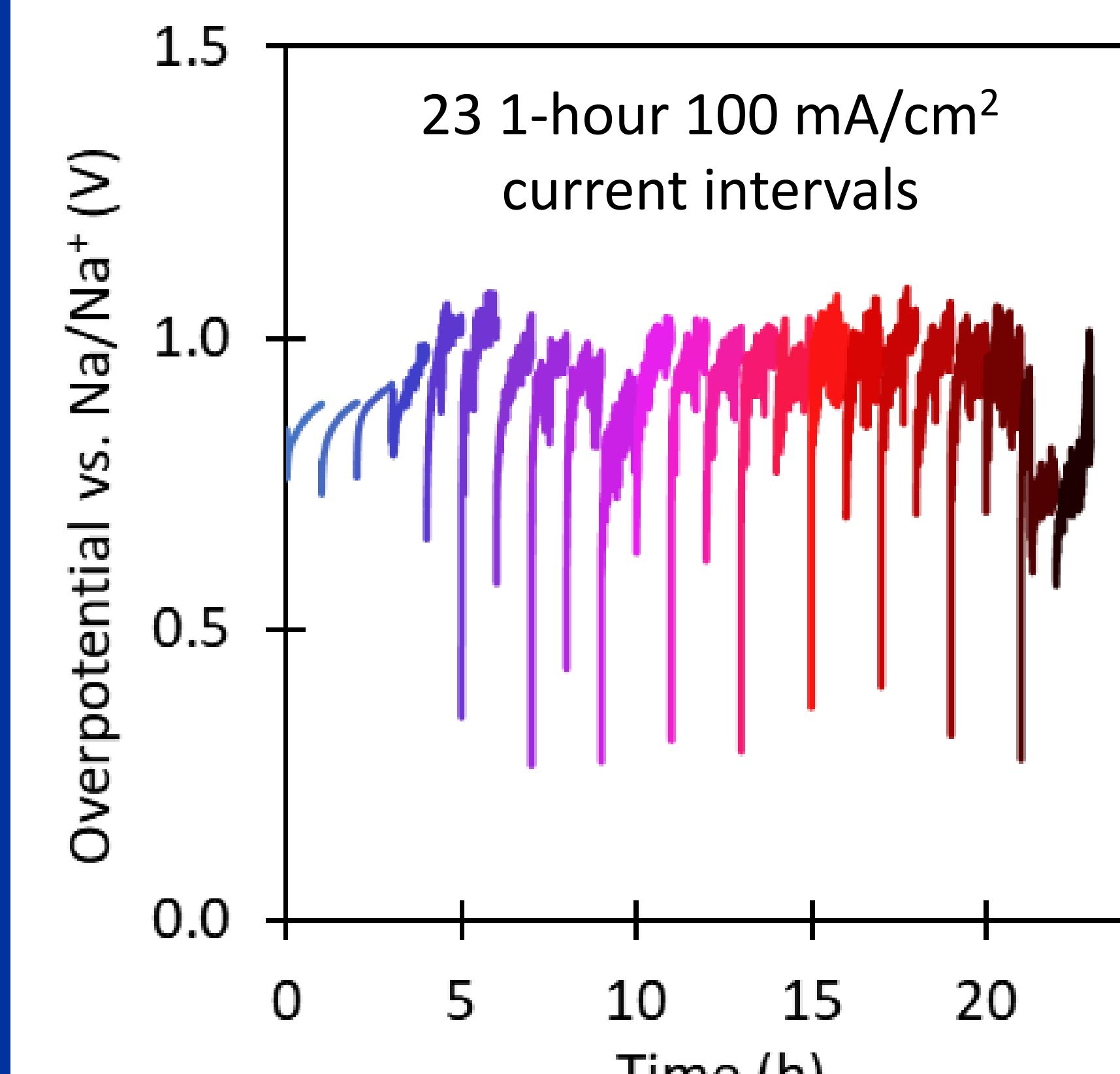
Motivation

The DOE Office of Electricity views sodium batteries as a priority in pursuing a safe, resilient, and reliable grid. Improvements in solid-state electrolytes are key to realizing the potential of these large-scale batteries.

- NaSICON structure consists of SiO_4 or PO_4 tetrahedra sharing common corners with ZrO_6 octahedra
- Structure forms “tunnels” in three dimensions that can transport interstitial sodium ions
- Higher ionic conductivity (at lower temperature) and cheaper to produce than β'' -alumina



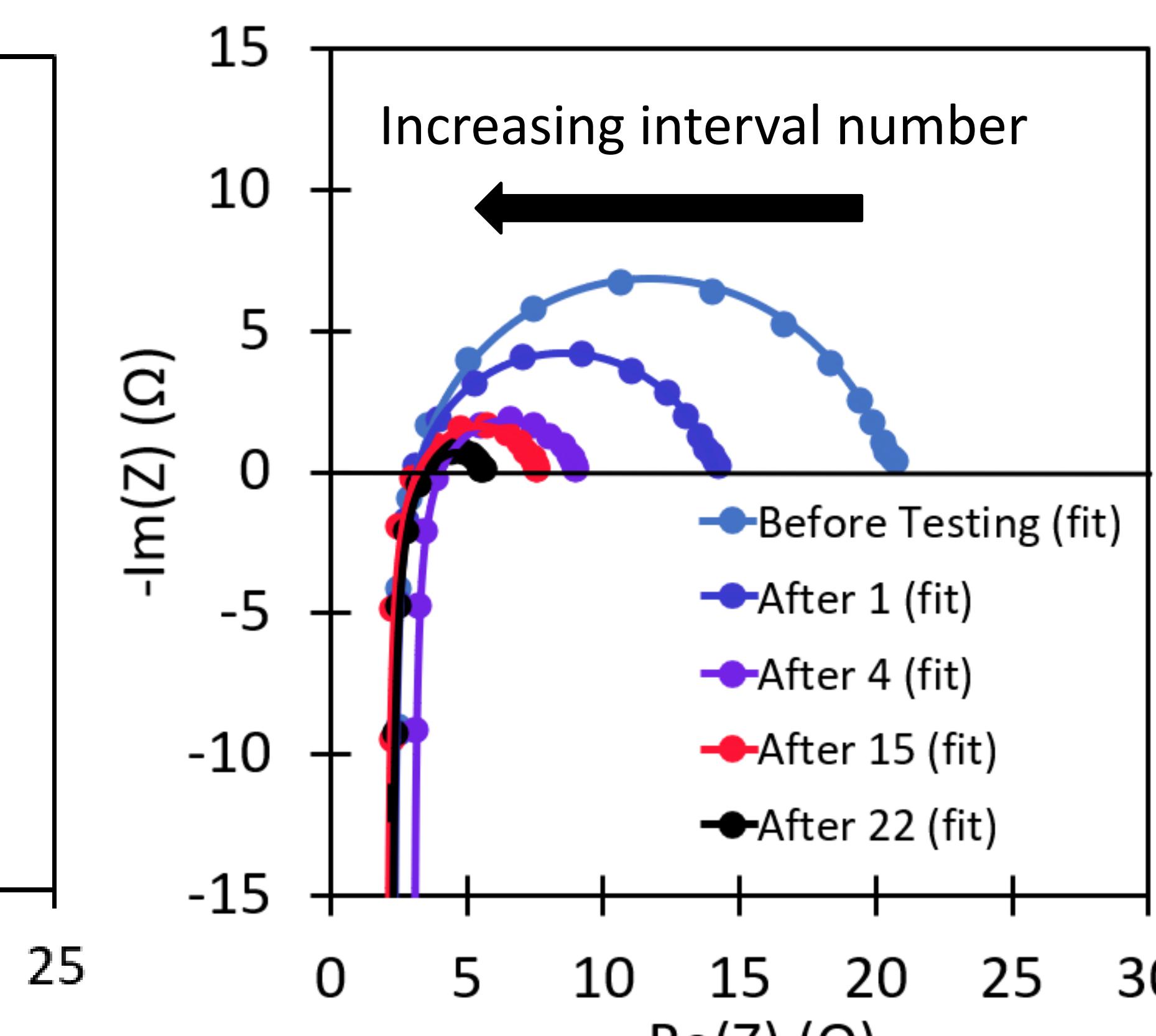
Initially, a stable voltage can be achieved at high current density (100 mA/cm^2)



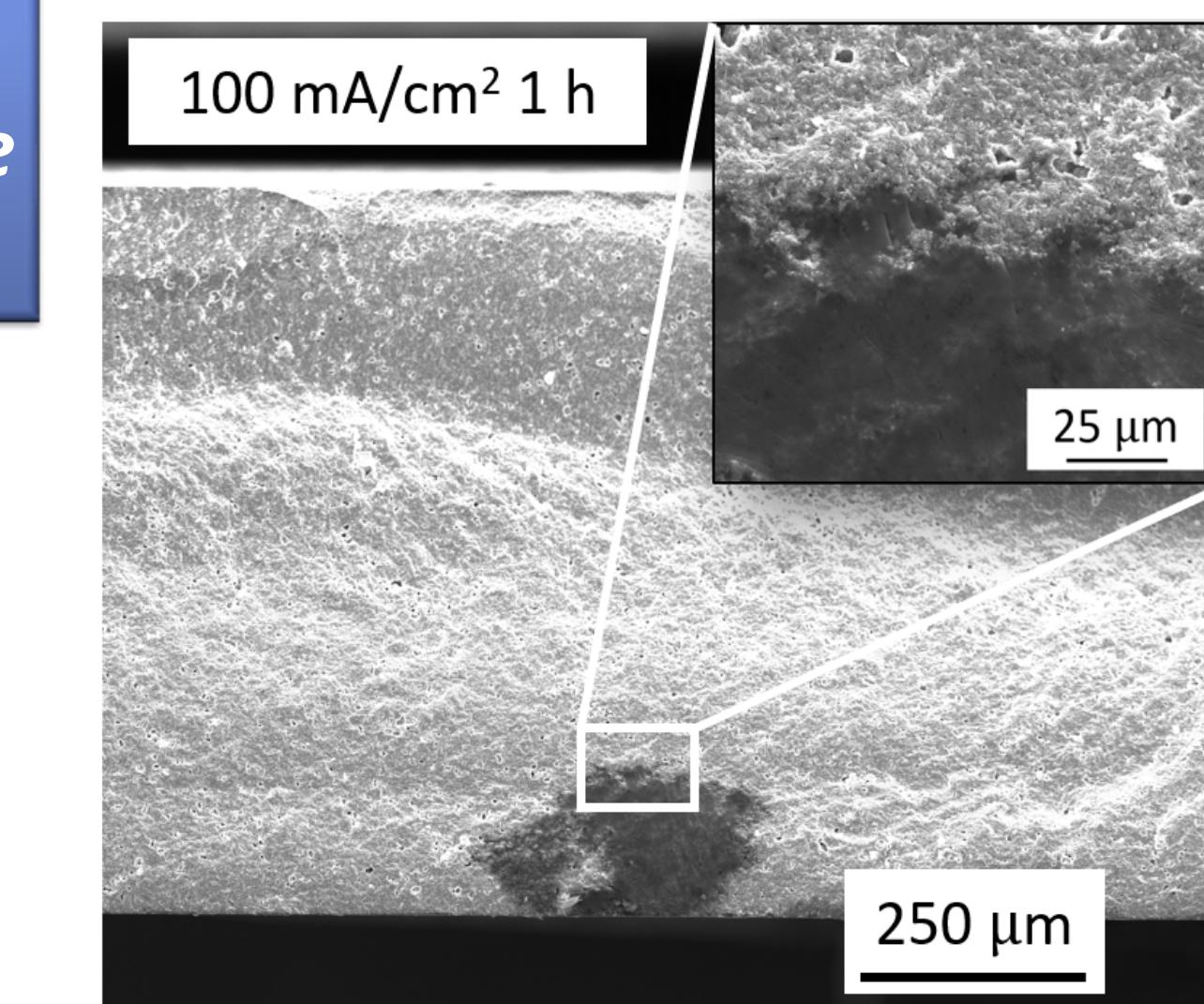
Symmetric Cell
Overpotential Profile

One-direction Current Symmetric Cell Testing of Bare NaSICON

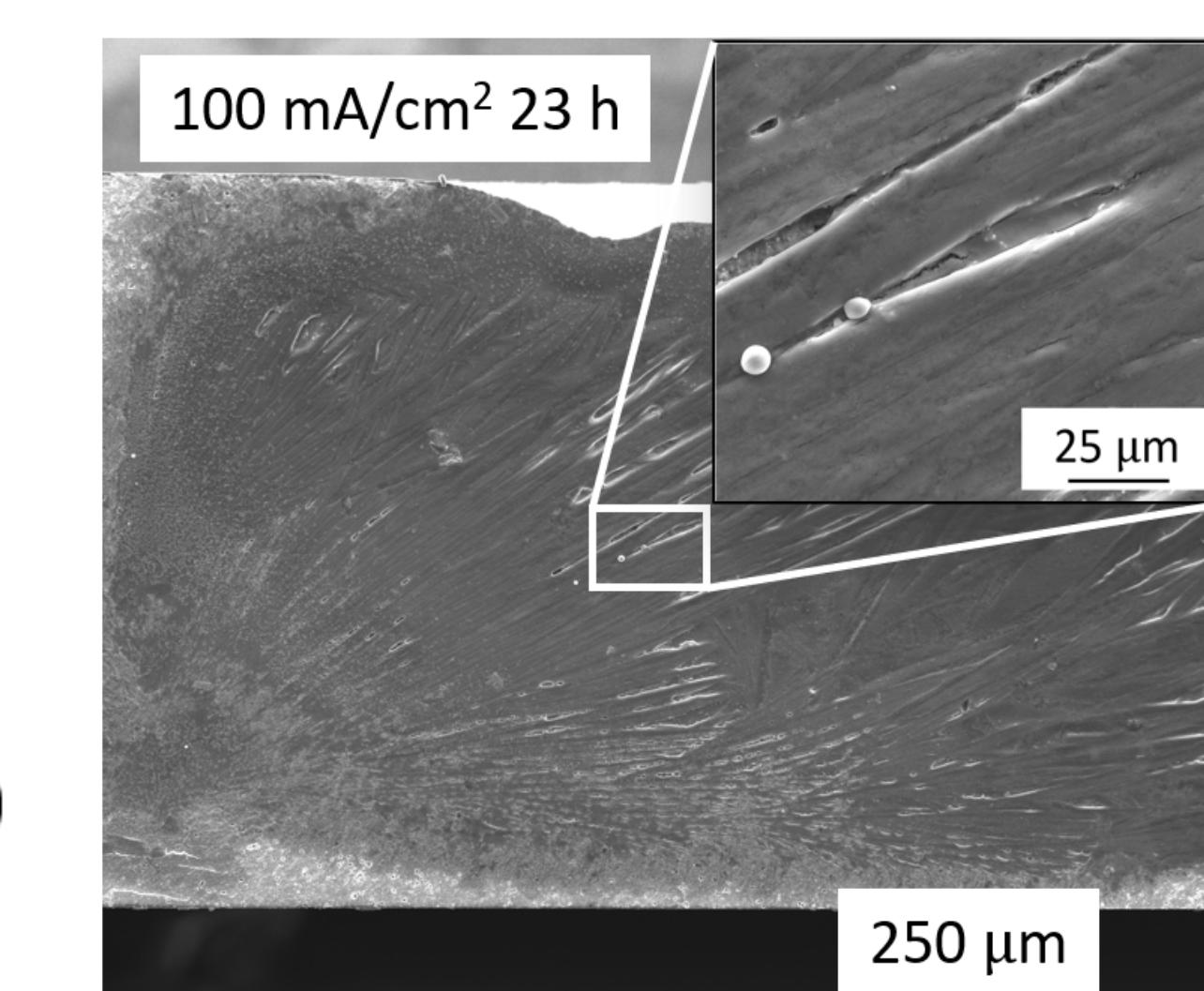
EIS shows a resistance decrease after each current interval – a visible decrease occurs when voltage becomes noisy



Symmetric Cell
EIS Spectra



Mode II
Degradation

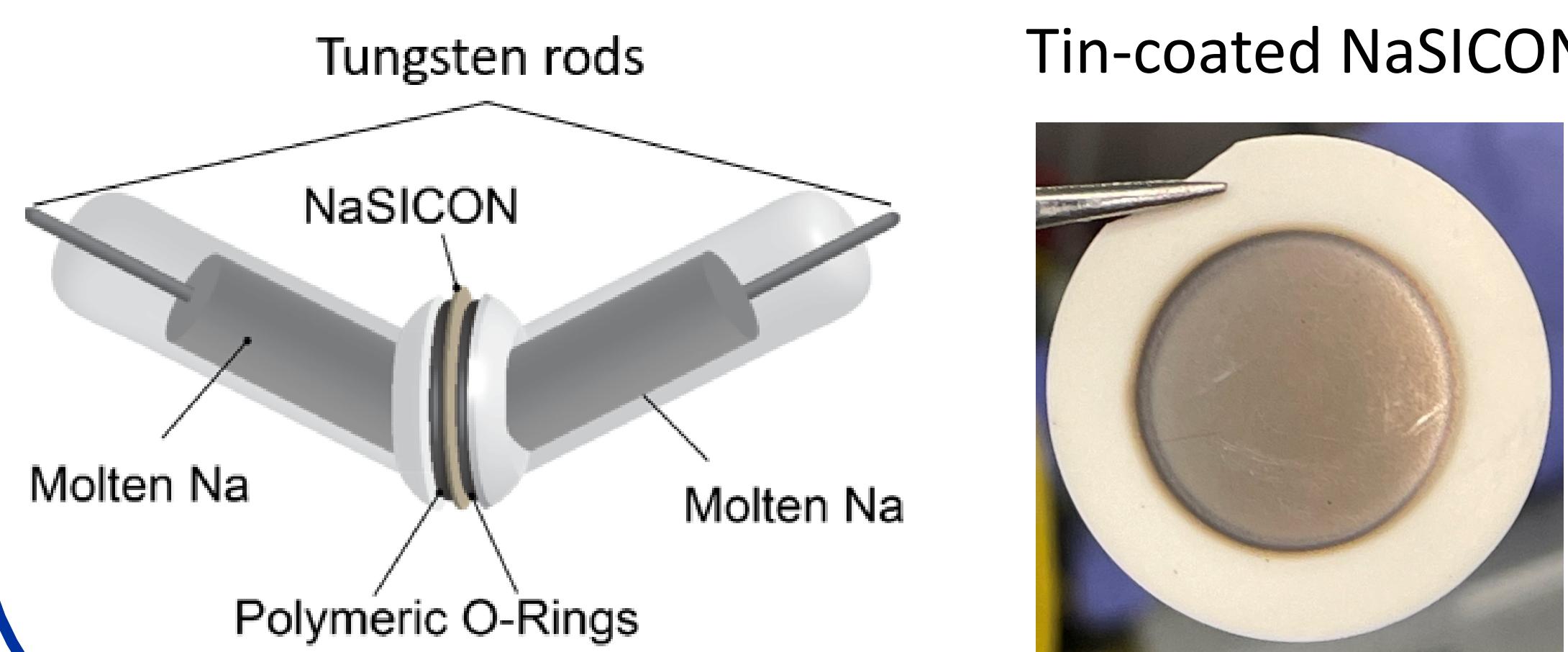
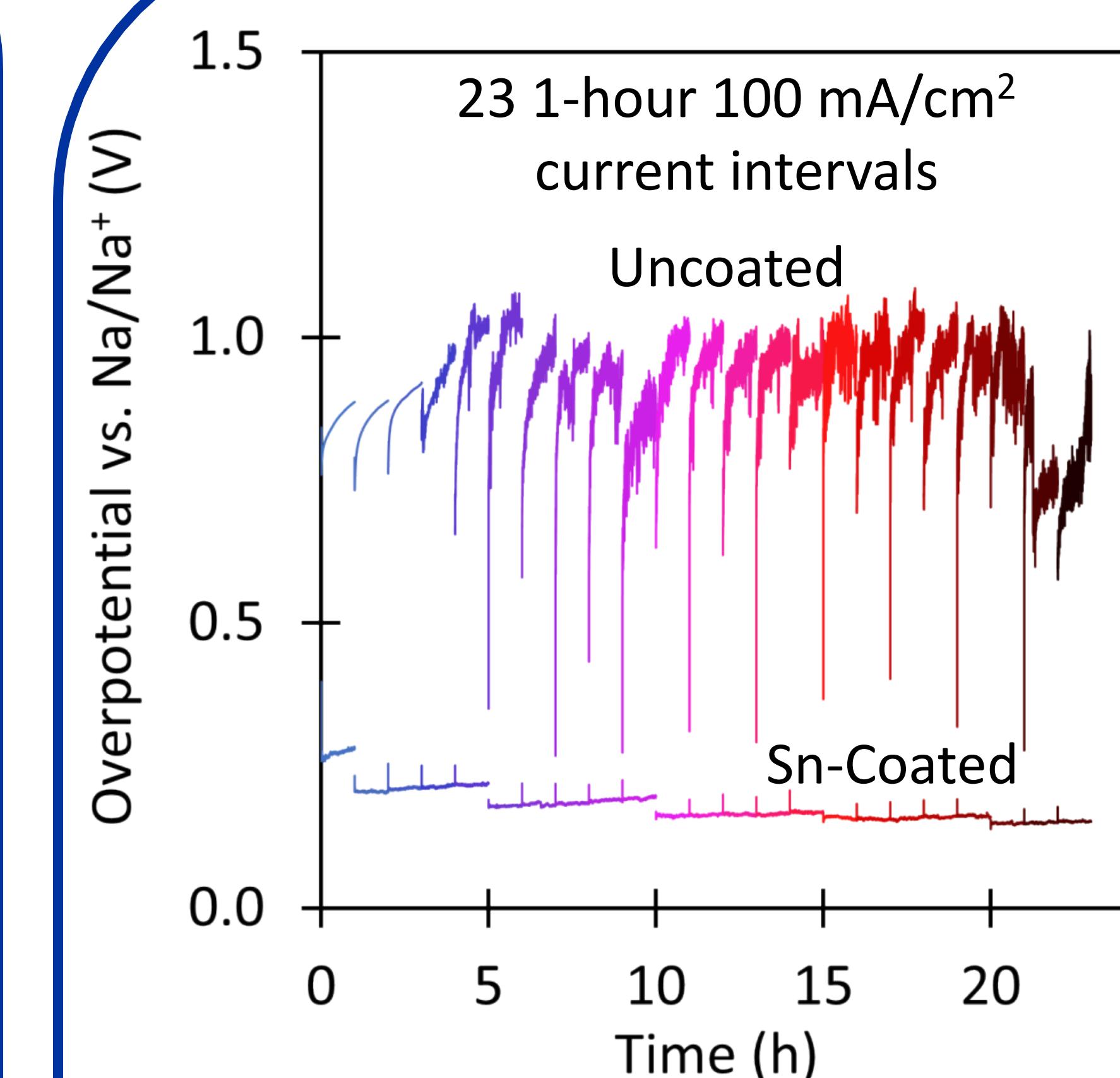


Mode I + II
Degradation

Cross-section
SEM Images

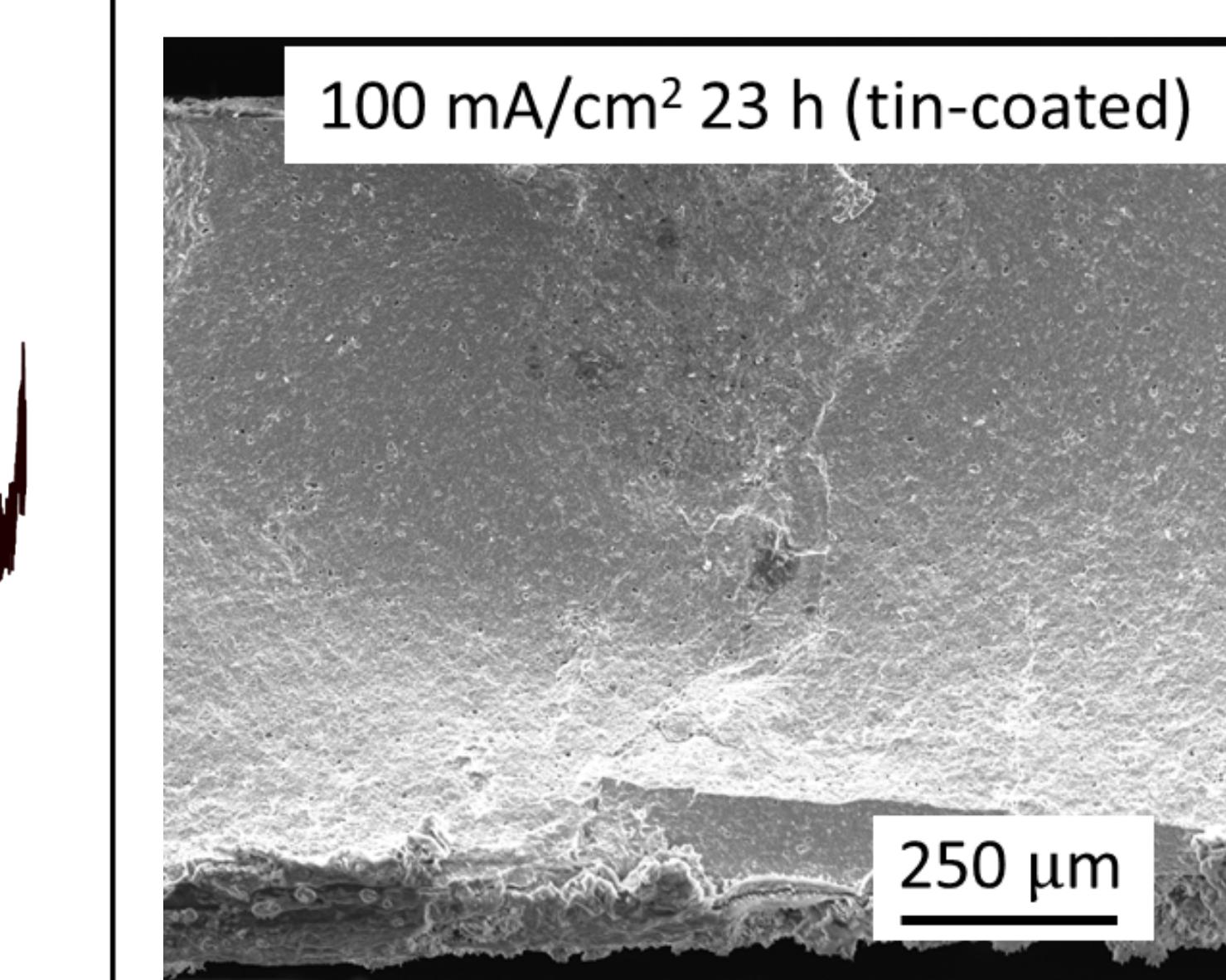
Objectives

- Identify mechanisms of dendrite initiation and propagation from molten Na electrodes using high-current (100 mA/cm^2), one-directional testing.
- Use classical electrochemical methods, such as electrochemical impedance spectroscopy (EIS), to further understand Na|NaSICON interface and detect initial dendrite formation.
- Use interfacial coating to eliminate dendrite formation and identify key properties for effective coatings.


Symmetric Cell Testing with Tin Coating


Overpotential Profiles

Tin coating eliminates interfacial resistance and allows for stable plating at high current density (100 mA/cm^2)



Cross-section of
Sn-coated NaSICON

Tin coating also eliminates dendrite formation, even at high current density

Conclusions and Future Work
Conclusions:

- Initially, high current densities (100 mA/cm^2) can be achieved in molten Na|NaSICON symmetric cells with a stable voltage profile
- After some time, the voltage profile becomes noisy
- EIS can be used to measure the cell impedance and a decrease in impedance corresponds to the increasingly noisy voltage profile
- NaSICON degradation can occur by both Mode I (pressure-induced cracking) and Mode II (ion-electron recombination) mechanisms
- Tin coating eliminates reduces interfacial resistance, eliminates dendrite formation, and enables stable plating

Future Considerations:

- What features (porosity, etc.) cause early degradation?
- How are mechanical properties related to sodium penetration?

Acknowledgments

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